

FILED UNDER 35 U.S.C. 371

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

10/089842

APPL NUM 10089842	FILING DATE 04/04/2002	CLASS 524	SUBCLASS 171	GAU 1714	EXAMINER [Signature]
**APPLICANTS: Matsuoka Hideo; Hamaguchi Mitsuhige; Kobayashi Kazuhiko; Todo Akira; Koda Taku;					
**CONTINUING DATA VERIFIED: THIS APPLICATION IS A 371 OF PCT/JP00/06984 10/06/2000					
** FOREIGN APPLICATIONS VERIFIED: JAPAN 11/290346 10/12/1999 JAPAN 11/358848 12/17/1999 JAPAN 2000-39191 02/17/2000					
PG-FUB DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed 35 USC 119 conditions met		<input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO 1099-02	
Verified and Acknowledged Examiner's initials					
TITLE : Resin structure and use thereof					
U.S. DEPT. OF COMM./PAT. & TM-PTO-436L(Rev. 12-94)					

BEST AVAILABLE COPY

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING		
Amount Due	Date Paid	Sheets Drwg.	Figs.Drwg.	Print Fig.
TERMINAL DISCLAIMER		Primary Examiner		
		Application Examiner		
PREPARED FOR ISSUE				
WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368. Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.				

FILED WITH: DISK (CRF) CD-ROM
(Attached in pocket on right inside flap)